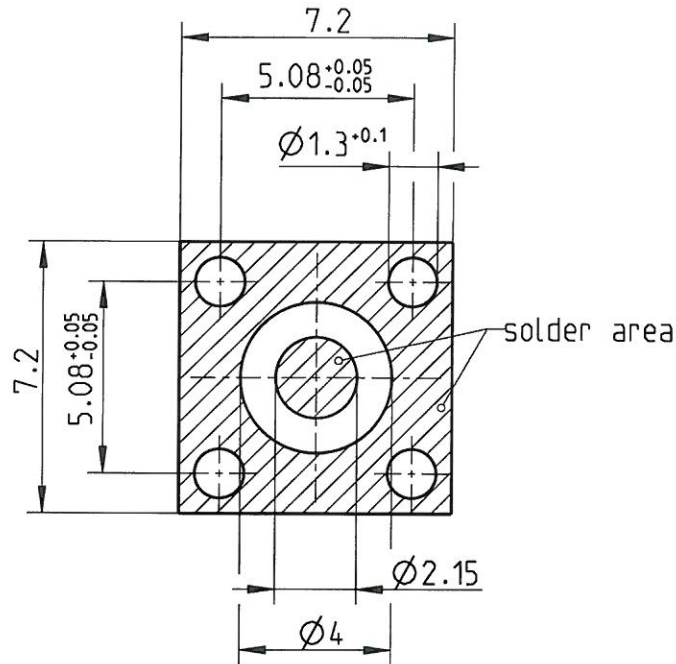


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Leiterplatten-Layout
PCB layout
B 126b



A wide variety of transmissionline topologies and pcb-parameters like permittivity, substrate thickness, and board-stackup are applied by customers. These parameters have a strong impact on the high frequency performance of the mounted connector.

Please note, that the given layout is not optimised to fit all of the possible board configurations regarding RF-performance, it represents a recommendation for optimum solderability of the connector.

In order to guarantee optimum high frequency properties of the connector, an RF-analysis of the connector to board transition is recommended.

Formblatt: TCC_FB_05_P2_A4_Einzelteil
Pfad: I:\Pse-entlo-rahmen\Datei: A:\Proj\126b.P2R
Version: 1.2

Dimensions in mm

ISO-Projektion Methode E

| | | | | | | | | | | | |
|--|--|--|--|---|--|---|--|--|--|--|--|
| Rosenberger Hochfrequenztechnik 84526 Tittmoning Pro/ENGINEER | | | | general tolerance ISO 2768 m-H | | RN 006-01 dimensions <0,5 and symmetry | | scale: 5:1 | | weight(g): surface(mm ²): | |
| | | | | date drawn 07.12.2009 check. 2.3.10 appr. 3.3.10 | | name T_Stadler | | title: <h2 style="text-align: center;">Leiterplatten-Layout PCB layout</h2> | | | |
| a00 10-s132 T_Stadler 02.03.2010 | | | | drawing-no.: MB_126B | | sheet: 1 | | | | | |
| 100 09-m625 T_Stadler 07.12.2009 | | | | distribution to: | | FE AZ QSM RMT . X | | of: 1 | | | |
| rev. change-no name date | | | | remarks: . | | | | | | | |